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i.MX Windows 10 IoT User's Guide

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User guide

Document information

Information	Content
Keywords	i.MX, Windows 10 IoT
	i.MX Windows 10 IoT User's Guide describes the process of building and installing Windows 10 IoT OS BSP (Board Support Package) for the i.MX platform. It also covers special i.MX features and how to use them.



1 Overview

The User's Guide describes the process of building and installing Windows 10 IoT OS BSP (Board Support Package) for the i.MX platform. It also covers special i.MX features and how to use them. The guide lists the steps to run the i.MX platform, including board DIP switch settings (see i.MX Windows 10 IoT Quick Start Guide, IMXWQSG) and instructions on the usage and configuration of U-Boot bootloader. Features covered in this guide may be specific to particular boards or SoCs. For the capabilities of a particular board or SoC, see i.MX Windows 10 IoT Release Notes (IMXWNR).

1.1 Audience

This chapter is intended for software, hardware, and system engineers planning to use the product and anyone who wants to know more about the product.

1.2 Conventions

This chapter uses the following conventions:

• Courier New font: This font is used to identify commands, explicit command parameters, code examples, expressions, data types, and directives.

1.3 How to start

The i.MX Windows 10 IoT BSP is a collection of binary files, source code, and support files you can use to create a bootable Windows 10 IoT image for i.MX development systems.

1.4 Using Prebuilt Binaries to create an image

The Prebuild Binary package contains prebuilt release-signed binaries of the drivers and firmware required for Windows 10 IoT Enterprise to run on the NXP i.MX development boards. It is the fastest way to get started running on physical hardware.

If you have downloaded the BSP with the Prebuilt Binaries, see i.MX Windows 10 IoT Quick Start Guide, which will guide you through creating a Windows IoT image that includes the BSP binaries and deploying it to an i.MX development board.

1.5 Using Source Files to create image

The BSP Source Files package contains the source files of the drivers and firmware required for Windows 10 IoT Enterprise to run on NXP i.MX development boards. It is intended to be used as a reference for partners that have created their own hardware designs that use the i.MX 8/9 families of SoCs and must customize the drivers and firmware for their own design.

If you have downloaded an archive with BSP sources, you must first build the Windows drivers and Boot firmware from the source before you can create a Windows IoT image and deploy it to your device. Start from Building Windows 10 IoT for NXP i.MX Processors, which will guide you through the process of building the Windows drivers and boot firmware from the source. Once you have successfully built the driver and firmware binaries, you can go back to the chapter in i.MX Windows 10 IoT Quick Start Guide that describes how to Deploy Windows IoT image to development board.

1.6 References

For more information about Windows 10 IoT Enterprise, see Microsoft online documentation.

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• http://windowsondevices.com

The following Quick Start Guides contain basic information on the board and setting it up. They are available on the NXP website.

- i.MX 8M Quad Evaluation Kit Quick Start Guide
- i.MX 8M Mini Evaluation Kit Quick Start Guide
- i.MX 8M Nano Evaluation Kit Quick Start Guide
- i.MX 8M Plus Evaluation Kit Quick Start Guide
- i.MX 8QuadXPlus Multisensory Enablement Kit

Documentation is available online at nxp.com

i.MX 8 information is at http://www.nxp.com/imx8

2 Building Windows 10 IoT for NXP i.MX Processors

2.1 Building the drivers in the BSP

2.1.1 Required tools

The following tools are required to build the drivers:

- git
- · git-lfs
- · software to unpack zip, gzip, and tar archives
- Visual Studio 2019
- Windows Kits (ADK/SDK/WDK)

2.1.1.1 Visual Studio 2019

- Make sure that you install Visual Studio 2019 before the WDK so that the WDK can install a required plugin.
- Download Visual Studio 2019.
- During installation, select Desktop development with C++.
- During installation, select the following in the Individual components tab. If these options are not available, try
 updating VS2019 to the Latest release:
 - MSVC v142 VS 2019 C++ ARM64 Spectre-mitigated libs (16.11)
 - MSVC v142 VS 2019 C++ ARM64 build tools (16.11)
 - Windows 10 SDK (10.0.19041.0)

2.1.1.2 Windows Kits from Windows 10, version 2004 (10.0.19041.685)

Warning: Make sure that any previous versions of the ADK and WDK have been uninstalled!

- Install ADK 2004
- Install WDK 2004
 - Scroll down and select Windows 10, version 2004.
 - Make sure that you allow the Visual Studio Extension to install after the WDK install completes.
- If the WDK installer says it could not find the correct SDK version, install SDK 2004
 - Scroll down and select Windows 10 SDK, version 2004 (10.0.19041.0).

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 After installing all Windows Kits, restart the computer and check if you have the correct versions installed in the Control panel.

2.1.2 Obtaining sources for building the drivers

For building the drivers, use the NXP i.MX BSP sources package provided as W<os_version>-imx-windows-bsp-
build_date>.zip. The package contains sources for both the boot firmware and Windows drivers.

2.1.2.1 Preparing source for building the drivers

To prepare sources for building drivers, follow these steps:

- 1. Create an empty directory, further referred as <BSP_DIR>, and extract the downloaded archive there. The path to this directory must be as short as possible, containing only letters and underscores. Braces and other special characters can cause build errors.
- 2. Populate the directory by running Init.bat.

2.1.3 Structure of Windows driver sources

The imx-windows-iot - sources of Windows drivers have the following structure:

BSP Contains boot firmware, driver binaries (generated at build time), and

scripts needed to deploy BSP to the development board.

build Contains build scripts, and the VS2019 solution file. components -

Contains third-party binaries and utility projects. driver - Contains driver

sources.

hals Contains hal extension sources.

2.1.4 One-time environment setup

To generate driver packages on a development machine, test certificates must be installed.

- 1. Open an Administrator Command Prompt.
- 2. Navigate to your BSP and into the folder imx-windows-iot\build\tools.
- 3. Launch StartBuildEnv.bat.
- 4. Run SetupCertificate.bat to install the test certificates.
- 5. The HAL Extensions must be signed by certificates provided by Microsoft. The required certificates that are included in WDK have expired. Download the Windows 11, version 22H2 EWDK and use the "Windows OEM HAL Extension Test Cert 2017 \(TEST ONLY\)" and "Windows OEM Intermediate 2017 \(TEST ONLY\)" found in the EWDK.iso file or contact Microsoft for help.

Some tools may not work correctly if LongPath is not enabled, therefore run the following command in the console:

Execute reg add HKEY_LOCAL_MACHINE\SYSTEM\CurrentControlSet\Control\FileSystem /v LongPathsEnabled /t REG DWORD /d 1 command.

2.1.5 Building the drivers

- 1. Open the solution imx-windows-iot\build\solution\iMXPlatform\iMXPlatform.sln located in the path where you have extracted BSP archive.
- 2. Choose Debug or Release build type.

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- 3. If the secure boot feature is enabled, it is required to use signed drivers.
- 4. To build, press Ctrl-Shift-B or choose Build -> Build Solution from the menu. It compiles all driver packages then imx-windows-iot\BSP\IoTEntOnNXP\drivers for deployment.
- 5. The updated drivers could now be injected into the installation image or manually installed to the running development board.
 - To manually install drivers, copy them to the development board via USB drive, network share, scp, remote desktop. The drivers can be installed either by clicking install in right-click menu of the 'inf' file or by the devcon command-line utility.
 - For debug, use the .kdfiles of WinDBG. To initiate the driver reload, use devcon or reset the board.
 - To create an installation SD card, see i.MX Windows 10 IoT Quick Start Guide.

2.2 Building ARM64 Firmware

This chapter describes the process of setting up a build environment to build the latest firmware and update the firmware on the development board.

2.2.1 Required tools

- git
- git-lfs
- · software to unpack zip, gzip, and tar archives

2.2.2 Obtaining sources for building ARM64 Firmware

For building the ARM64 Firmware you will need:

- 1. The NXP i.MX BSP sources package available at www.nxp.com. The package contains sources for both the boot firmware and Windows drivers.
- 2. The i.MX firmware and NXP Code Signing Tool (CST). Obtaining is described in Section 2.2.2.1.

2.2.2.1 Preparing sources for building firmware

1. Create an empty directory, further referred as <BSP DIR>, and extract the downloaded archive there.

```
unzip W<os version>-imx-windows-bsp-<build date>.zip -d win10-iot-bsp
```

The command creates the win10-iot-bsp directory containing .git repository with the BSP release.

Note: The path to this directory must be as short as possible, containing only letters and underscores.

Braces and other special characters can cause build errors.

2. Populate the directory by running Init.sh.

Note: Script checks out sources from the repository by git reset --hard. The Init.sh shall also check out submodules that are required to build i.MX boot firmware by git submodule update --init --recursive. During prerelease testing, the Init.sh executed inside Ubuntu environment has run into "server certificate verification failed. CAfile: /etc/ssl/certs/ca-certificates.crt CRLfile: none" error. The problem could be solved by installing apt-transport-https ca-certificates and certificate update.

```
sudo apt update ; sudo apt-get install apt-transport-https
ca-certificates -y ; sudo
\update-ca-certificates
```

3. Extract the Code Signing Tool inside the bsp repository and rename the newly created folder to cst to get the <BSP DIR>/cst folder:

```
tar xf cst-3.1.0.tgz
```

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```
mv release cst rm cst-3.1.0.tgz
```

4. Extract the <u>i.MX firmware</u> from the NXP website and place it in firmware-imx.

```
chmod +x firmware-imx-8.18.bin
./firmware-imx-8.18.bin
mv firmware-imx-8.18 firmware-imx
rm firmware-imx-8.18.bin
```

Note: It extracts the tool inside the bsp repository and renames the newly created folder to firmware-imx to get <BSP DIR>/firmware-imx/firmware/ ddr/in directory tree.

5. Your directory structure must contain the following folders.

```
- <BSP_DIR>
|- cst (manually downloaded)
|- firmware-imx (manually downloaded)
|- Documentation
|- MSRSec
|- RIoT
|- imx-atf
|- imx-mkimage
|- imx-optee-os
|- imx-windows-iot
|- mu_platform_nxp
|- patches
|- uboot-imx
```

2.2.3 Setting up your build environment

- 1. Start Linux environment such as:
 - · Dedicated Linux system
 - · Linux Virtual Machine
 - Windows Subsystem for Linux (<u>WSL setup instructions</u>) **Note:** W-imx-windows-bsp-.zip was validated with Ubuntu 20.04 in WSL and also in standalone Ubuntu.
- 2. Obtain and prepare the BSP sources by following all steps described in Obtaining BSP sources. Use Init.sh not Init.bat to populate the repository and all submodules.
- 3. Install or update build tools. The shell commands below can be used to do this process on Ubuntu 20.04 or 18.04.

```
sudo apt-get update
sudo apt-get upgrade
```

4. If Ubuntu 18.04 and possibly other older distributions are used, the mono package might be outdated causing the build to fail. For such distributions, add the mono repository to the system as described in https://www.mono-project.com/download/stable/#download-lin before installing the mono package.

```
sudo apt install gnupg ca-certificates
sudo apt-key adv --keyserver hkp://keyserver.ubuntu.com:80 --recv-keys \
    3FA7E0328081BFF6A14DA29AA6A19B38D3D831EF
# Optionally key could be downloaded to a file and added manually by
# 'apt-key add KEYFILE'. Now that certificate is installed we can
# add official mono repository to repository list.
echo "deb https://download.mono-project.com/repo/ubuntu stable-bionic main" \
    | sudo tee /etc/apt/sources.list.d/mono-official-stable.list
```

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```
sudo apt update
```

Note: The process is valid for Ubuntu 18.04 in December 2021:

5. Install the required software. Note that the mu project currently requires python 3.8 and higher.

```
sudo apt-get install attr build-essential python3.8 python3.8-dev \
  python3.8-venv device-tree-compiler bison flex swig iasl uuid-dev \
  wget git bc libssl-dev zlib1g-dev python3-pip mono-devel gawk libgnutls28-
dev
```

6. Download the Arm64 cross-compiler.

```
pushd ~
wget https://releases.linaro.org/components/toolchain/binaries/7.4-2019.02/\
aarch64-linux-gnu/gcc-linaro-7.4.1-2019.02-x86_64_aarch64-linux-gnu.tar.xz
tar xf gcc-linaro-7.4.1-2019.02-x86_64_aarch64-linux-gnu.tar.xz
rm gcc-linaro-7.4.1-2019.02-x86_64_aarch64-linux-gnu.tar.xz
# The cross compiler prefix is required to be exported later
# into AARCH64_TOOLCHAIN_PATH variable.
# export AARCH64_TOOLCHAIN_PATH=~/gcc-linaro-7.4.1-2019.02\
# -x86_64_aarch64-linux-gnu/bin/aarch64-linux-gnu-popd
```

7. Change the directory to the BSP_DIR. The following commands reference the files inside the BSP directory. That BSP_DIR contains extracted W-imx-windows-bsp-.zip.

```
cd BSP DIR
```

8. <u>Project MU</u> strongly suggests the use of Python Virtual Environment for each workspace. In this case, BSP revision-separated environments allow workspaces to keep specific Pip module versions without modifying the global system state when the firmware is compiled.

```
python3.8 -m venv <path to new environment>
source <path to new environment>/bin/activate
eg.:
python3.8 -m venv ~/venv/win_fw_build
source ~/venv/win_fw_build/bin/activate
```

The virtual environment does not use system packages. Thus, do not use sudo when installing packages using pip.

- 9. Install the required python packages.
 - a. Install or update mu platform Python dependencies using pip.

```
pushd mu_platform_nxp
pip3 install -r requirements.txt --upgrade
```

b. Install the pycryptodome package (successor of pycrypto).

```
pip3 install pycryptodome
```

c. Install the pyelftools package.

```
pip3 install pyelftools
```

d. Install the cryptography package.

```
pip3 install cryptography
```

- 10. Setup the Mu platform. (This step is optional because buildme64.sh does these steps automatically.)
 - a. Setup and update submodules.

```
python3 NXP/MX8M_EVK/PlatformBuild.py --setup
```

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Note: If you return here facing problems during UEFI build, use --force to clean the environment. Make sure to commit or stash all your changes first. The --force argument performs git reset -hard.

b. Initialize and update Mu platform dependencies.

```
python3 NXP/MX8M EVK/PlatformBuild.py --update
```

Note: If this command fails, try upgrading mono. The best way to do it is to uninstall mono and reinstall it from its official repository. The process is described at https://www.mono-project.com/download/stable/#download-lin.

11. Return to BSP root.

popd

2.2.4 Building the firmware

To build the boot firmware:

1. Open cmd prompt inside BSP DIR.

```
cd <BSP DIR>
```

2. Activate your python virtual environment (Use the path specified when creating the environment.)

```
source ~/venv/win fw build/bin/activate
```

3. Export AARCH64_TOOLCHAIN_PATH cross compiler prefix. In this guide, the toolchain has been placed inside home (~/) directory.

```
export AARCH64_TOOLCHAIN_PATH=~/gcc-linaro-7.4.1-2019.02-x86_64_aarch64-/
linux-gnu/bin/aarch64-linux-gnu-
```

- 4. Optionally, if there is a major update, you may need to step into mu_platform_nxp and run python3 NXP/MX8M_EVK/PlatformBuild.py with --setup --forceand then --update manually. To get clean and up-to-date MU build environment, make sure to stash or commit your changes. The command performs git reset --hard.
- 5. Build the firmware and create firmware.bin. To build the boot firmware, execute the buildme64.sh -b <BOARD NAME> -t all [-clean] script provided in BSP DIR (the root of extracted BSP sources).

```
./buildme64.sh -b MX8M EVK -t all -c
```

The buildme64.sh script bundled in BSP also copies flash.binand uefi.fit into <BSP_DIR> / imx-windows-iot/components/Arm64BootFirmware/<board_name>. It allows to rebuild only UEFI or U-boot.

- Use -b MX8M EVK or -b 8M to select i.MX 8M EVK
- Use -b MX8M MINI EVK or -b 8Mm to select i.MX 8M Mini EVK
- Use -b MX8M NANO EVK or -b 8Mn to select i.MX 8M Nano EVK
- Use -b MX8M PLUS EVK or -b 8Mp to select i.MX 8M Plus EVK
- Use -b MX8QXP_MEK or -b 8X to select i.MX 8QXP_MEK
 Use -b MX93 11X11 EVK or -b 93 to select i.MX 93 EVK
- Use -t secured_efi to build signed_firmware_uuu.bin Options for builds:
- -b|-board specifies the board for which binaries will be built
 - all = build all devices,
 - 8M, MX8M EVK
 - 8Mm, MX8M MINI EVK
 - 8Mn, MX8M_NANO_EVK

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NXP Semiconductors

i.MX Windows 10 IoT User's Guide

- 8Mp, MX8M PLUS EVK
- 8X, MX8QXP MEK
- 93, MX93 11X11 EVK
- -t|-target app specifies target to build
 - all = build all components
 - u | uboot = build u-boot (by default with UUU tool)
 - optee = build optee core
 - apps | tee apps = build optee trusted applications
 - uimg | uboot image = create bootable image
 - tools | uefi tools = build UEFI tools
 - uefi = build UEFI
 - profile dev = build UEFI with development profile (set by default)
 - profile secure = build UEFI with secure profile
 - profile frontpage = build UEFI with frontpage profile
 - secured_efi|secured_uefi = build UEFI in secure mode + sign image(the name of the resulting firmware is prefixed with signed)
- [-cap|-capsule] creates capsule
- [-c|-clean] cleans build files before build
- [-fw|-fw bin] requests build of firmware from existing binaries
- [-nu|-no_uuu] builds uboot without UUU tool (the name of the resulting firmware does not contain _uuu suffix)
- [-h|-help] prints manual for script usage
- [-bc|build configuration] specifies build configuration of UEFI (RELEASE is selected as default)
 - release or RELEASE = for Release version of uefi
 - debug or DEBUG = for Debug version of uefi
- [-ao|-advance option] Advanced options for experienced users
 - rpmb reset fat = clears RPMB FAT
 - rpmb write key = writes RPMB KEY into RPMB
 - no_rpmb_test_key = uses Hardware-Unique key (HUK) instead of TEST_KEY (TEST_KEY is used as default)
 - optee core v = turns on verbose mode of OpTEE core
 - optee core vv = turns on the highest verbose mode of OpTEE core
 - optee ta v = turns on verbose mode of OpTEE trusted applications
 - optee ta vv = turns on the highest verbose mode of OpTEE trusted applications
- [TARGET_WINDOWS_BSP_DIR] Specifies path to imx-windows-iot, in which the firmware shall be updated.
- [KEY ROOT] specifies path to custom PKI root
- 6. To deploy firmware_uuu.bin to the i.MX development board, follow the process described in i.MX Windows 10 IoT Quick Start Guide.

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2.2.5 Common causes of build errors

- 1. ImportError: No module named Crypto.PublicKey.
 - This error is encountered when the pycryptodome module is missing or in case obsolete pycrypto is removed.
- 2. Unable to enter directory. Directory does not exist.
 - We have run into this problem in case gitmodules were not downloaded completely (for example, MSRSec is empty) or cst or firmware directories were missing. Try repeating the Obtaining BSP sources step by step.
- 3. The build fails in WSL while the BSP is located somewhere in /mnt/c of the WSL.
 - Try setfattr -n system.wsl_case_sensitive -v 1 <BSP_DIR>. OP-Tee also requires symbolic links. We have been able to build boot firmware in /mnt/c/ on Windows OS version 1909. Workaround is to copy the BSP to WSL filesystem, for example, to HOME.

3 Display/GPU driver

This chapter contains several notes related to windows i.MX Gpu driver. Kernel graphic driver consists among others of gpu driver <code>galcore.sys</code> and display controller driver <code>dispctrl.dll</code>. Setup information file <code>galcore.inf</code> contains several parameters that are written into Windows registry database and later used for the driver configuration. To change these parameters, either update registry database directly under <code>HKEY_LOCAL_MACHINE\SYSTEM\CurrentControlSet\Control\Class\{4d36e968-e325-llce-bfcl-08002bel0318}\00000 key, or update INF file and uninstall/re-install gpu driver, and then reboot.</code>

3.1 Display interface selection

The following Registry (INF) parameter is used to select the display interface for a particular display. Applicability is platform-dependent, see features list for particular platform in Quick Start Guide and limitations in Release Notes. If a platform supports only one possibility, the parameter is ignored. For specific hardware configuration, see the platform reference manual.

Display<n>Interface (where <n> display id = 0,1,2,...) parameter is of REG DWORD type.

Possible values:

```
DISP_INTERFACE_HDMI = 0x1

DISP_INTERFACE_MIPI_DSI0 = 0x2

DISP_INTERFACE_MIPI_DSI1 = 0x3

DISP_INTERFACE_LVDS0 = 0x4

DISP_INTERFACE_LVDS1 = 0x5

DISP_INTERFACE_LVDS_DUAL0 = 0x6

DISP_INTERFACE_PARALLEL LCD = 0x7
```

3.2 Display resolution and timing parameters

Display resolution is configured differently for individual display interfaces.

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3.2.1 HDMI display interface

The display is configured with native display resolution read from the EDID of the connected display. Typically, this is 1920x1080@60 Hz for most standard HDMI monitors. It is not possible to change/override the native resolution.

Currently, maximum resolution supported by display driver is 1080p (1920x1080@60 Hz), which is also set if native display resolution exceeds this maximum.

3.2.2 LVDS, MIPI-DSI and Parallel display interfaces

Display resolution and timing parameters are obtained from following registry parameter:

Display<n>EDID (where <n> display id = 0,1,2,...), parameter is of REG_BINARY type.

The parameter contains EDID data encoded according to EDID structure v1.4 data format (standard published by VESA). The first data block 128 bytes long is used, that is, only basic EDID structure without any extensions. Resolution and timing parameters are parsed from Standard timing information - Descriptor 1 (offsets 54 - 71), specifically pixel clock, horizontal active pixels resp. vertical active lines, blanking pixels, synchronization pulse width, front porch, and VSYNC, HSYNC signals polarity. During EDID loading from registry, EDID header is checked (offsets 0 - 7) and checksum must match (offset 127). Other EDID data are irrelevant to gpu driver. Default EDID data in INF file sets 1280x720@60 Hz mode.

BSP package contains pre-prepared testing EDID data for several standard modes: see <BSP>\imx-windows-iot\driver\display\dispdll\util\include\edidtst.h

3.3 Display specific parameters

3.3.1 LVDS display interface

Registry (INF) parameters related to LVDS interface:

- Display<n>BusDataWidth (where <n> is display id = 0,1,2,...) parameter of REG_DWORD type determines the number of pixels mapped to the output signal. Supported are 24 bpp or 18 bpp. The default value is 24.
- Display<n>BusMapping (where <n> is display id = 0,1,2,...) parameter of REG_DWORD type determines the pixel mapping type in the output signal. Supported are DISP_BUS_MAPPING_SPWG = 0x1 or DISP_BUS_MAPPING_JEIDA = 0x2. The default value is 0x1.

3.3.2 MIPI-DSI display interface

Registry (INF) parameters related to MIPI-DSI interface:

- Display<n>NumLanes (where <n> is display id = 0,1,2,...) parameter of REG_DWORD type determines number of DSI lanes. Possible values 1-4, default value is 4.
- Display<n>ChannelId (where <n> is display id = 0,1,2,...) parameter of REG_DWORD type determines virtual channel ID of the display. The default value is 0.

3.4 Display support in firmware

Display-related peripherals are configured in u-boot for i.MX 8M and i.MX 8QXP and the following paragraphs are not valid for them. The following description is related to the firmware driver for i.MX 8M Plus, i.MX 8M Nano, i.MX 8M Mini and i.MX 93.

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3.4.1 Firmware display interface selection

The firmware display interface can be selected in the giMX8TokenSpaceGuid.PcdDisplayInterfac e parameter in the platform description file (dsc) located in <BSP>/mu_platform_nxp/NXP/<Board>/ <Board>.dsc. Possible values are HDMI = 0, MIPI_DSI = 1, LVDS0 = 2, LVDS1 = 3, LVDS dual = 4. The available display interfaces are dependent on specific boards (see Release Notes or SoC reference manual for more information). The parameter is used for interfaces, which do not allow automatic detection.

Automatic detection is implemented for HDMI-based display interfaces, that include IMX-MIPI-HDMI (MIPI-DSI to HDMI converter), IMX-LVDS-HDMI (LVDS to HDMI converter), and native HDMI interface. These interfaces are probed in the same order of priority and if successfully detected, giMX8TokenSpaceGuid.PcdDisplay Interface is overridden with the detected display interface.

After changing any of the parameters, the fimrware must be recompiled.

3.4.2 Firmware display resolution

Firmware display resolution is stored in the PreferredTiming variable. This variable is initialized in the LcdDisplayDetect function in the iMX8LcdHwLib.c or iMX93DisplayHwLib.c file respectively. These source files contain several pre-defined resolutions and timing parameters. For example, to select 1024x768@60 resolution initialize the PreferredTiming variable: LcdInitPreferredTiming (&PreferredTiming 1024x768 60, &PreferredTiming);

For HDMI-based display interfaces (see previous paragraph), the giMX8TokenSpaceGuid.PcdDisplay ReadEDID parameter (TRUE/FALSE) allows enabling/disabling EDID reading. The resolution and display parameters are then extracted from the Detailed Timing descriptor of EDID data (native resolution). The gi MX8TokenSpaceGuid.PcdDisplayForceConverterMaxResolution parameter (TRUE/FALSE) allows to clamp display resolution to the supported maximum, that is, if the EDID Detailed Timing descriptor contains a resolution higher than the supported maxim, EDID data are discarded, and supported maximum resolution is used instead. Both these parameters are located in the platform description file (dsc) - see the previous paragraph.

After changing any of the parameters, the fimrware must be recompiled.

Note: Only a limited set of pixel clocks is supported, so for a new resolution with a pixel clock different than pre-defined in the above source files, the corresponding clock driver must be updated.

4 Power management

Power management consists of the **Processor Power Management (PPM)** that includes low-power state transition of processor cores and of the **Device Power Management (DPM)** that includes power gating and clock gating of individual devices. An important part of customization of power management is the **Power Engine Plugin (PEP) driver** that defines processor and platform low-power states and can handle power and clock gating for individual devices. This chapter contains notes regarding the current support of power management for i.MX 8/9 platforms, relevant tools, and utilities.

4.1 Power management user scenarios

We consider 2 power scenarios that could be of interest for vendors using i.MX 8/9 platforms:

- At runtime: reduce runtime power consumption by putting unused resources to temporary possibly short sleep states:
 - devices to clock gating/power gating or other low-power states, for example, D3/F1, CPUs to CPU-suspend in Standby or PowerDown mode.
- When IoT device is idle: platform entering low-power idle states (wait state, power off state) with minimal power consumption and wake-up capability via selected devices.

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4.2 Device power management DPM on i.MX 8/9 platforms

There are working samples of **power management framework (PoFx)** callbacks in I2C and PWM drivers. The functionality must be enabled by I2C POWER MANAGEMENT and PWM POWER MANAGEMENT macros.

The **Dx states** are Devices states (D0=Running, D3=low power)

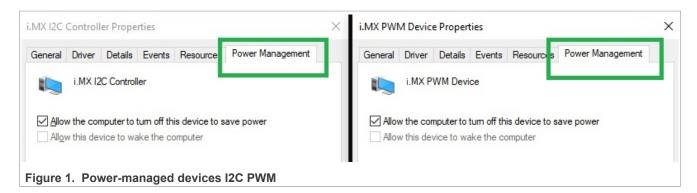
The Fx states are Components states (F0=Running, F1=low power)

The i.MX 8/9 implementation is based on the Single Component KMDF Power Framework (PoFx) Sample provided by Microsoft.

The power state transitions from D0/F0 to D3/F1 and back are based on device activity (for example, running some test traffic). The device power state can be checked in WinDbg using the <code>!fxdevice</code> command. The state transition happens based on OS decision (made incl. the S0 Idle Timeout), and the driver is notified using the <code>PO_FX_COMPONENT_IDLE_STATE_CALLBACK</code>. It must change HW status to low power (if State > 0) or to running (if State = 0). The functionality is located in files <code>imxi2cpofx.h/cpp</code> and <code>imxpwm_pofx.h/cpp</code>. The PoFx functionality can be copied to other drivers based on specific vendor requirements.

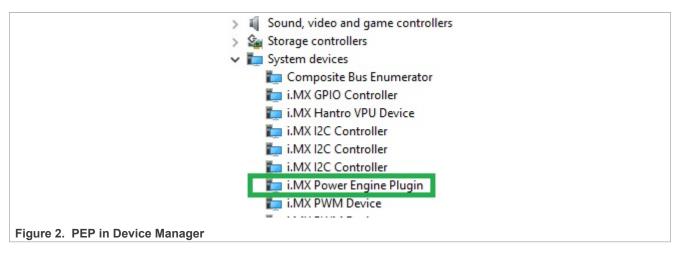
The Device driver interacts with Windows PoFx framework using the <u>WdfDeviceAssignS0IdleSettings</u> and <u>WdfDeviceAssignPowerFrameworkSettings</u> methods.

When the power management support is implemented in the device driver, the Power Management tab becomes visible in the device properties in the Device Manager:



4.3 Processor power management PPM on i.MX 8/9 platforms

The **Power Engine Plugin (PEP) driver** is visible in Device Manager -> System devices for all the supported i.MX 8/9 boards:



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The PEP handles putting of CPU cores to coordinated low-power (sleep) states as requested by the operating system. The call sequence that puts CPU core to sleep looks like follows:

The sleeping CPU core is woken from sleep state by interrupt, either a Processor to Processor Interrupt (PPI) for example, IRQ27 or by device interrupt IRQ > 32, for example, a USB device like mouse or keyboard. See section related to IRQs.

PEP and Imx-Atf: ATF is the Arm Trusted Firmware, integrated with Uefi and Uboot in firmware.bin. The ATF implements the PowerStateCoordinatedInterface (PSCI industry standard, DEN0022E_Power_State_Coordination_Interface.pdf) from ARM specification, incl. the CPU_SUSPEND method used to put CPU cores into low-power sleep states. The CPU_SUSPEND can specify either standby or Power-down mode. When the last CPU core goes into the low-power Power-down mode, the whole platform must enter the platform power down, which includes DDR self-refresh, and setup for wake-up using selected interrupts. In Release Milestone 6, the platform power down is not yet fully integrated with Win10 IoT OS so it needs more effort to have this functional.

The PEP also ensures that before entering the Coordinated low-power state (defined in PEP) all devices are in required low-power state. This is defined in PEP: DpmDeviceIdleContraints, the constraints are expected to be extended in future releases.

PEP and WinDbg: the PEP driver is loaded in Windows OS as one of the first drivers during startup. It can be replaced and debugged with WinDbg as usual. Enable the #define DBG_MESSAGE_PRINTING in image dbg.h file to get traces in the WinDbg command window.

4.4 Power management tools and debugging

The following tools can be used to analyze current Power management functionality:

Utility	Description
powercfg /a	Available sleep states
powercfg /sleepstudy	Sleep study HTML report
powercfg /energy	Energy efficiency analysis and issues
WinDbg !fxdevice	Device power management status

4.4.1 powercfg/a

This command displays the available sleep states.

In i.MX which uses the Modern Standby the only supported state is the **S0 Low Power Idle - Network Connected**.

```
C:\> powercfg /a
The following sleep states are available on this system:
```

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Standby (SO Low Power Idle) Network Connected

4.4.2 powercfg/sleepstudy

This command generates a detailed HTML report with analysis of sleep-states during last 3 days.

It includes how many % of time was spent in Deepest Runtime Idle Platform State (DRIPS) during each Sleep period.



4.4.3 powercfg /energy

This command generates the energy consumption analysis and issues report.

4.4.4 WinDbg !fxdevice

The fxdevice command gives detailed status and history of power state transition of each power managed device.

For example I2C2 in D0 state when active, in D3 state (power down) when idle, and the PoFx IRP log:

```
!fxdevice ... find the relevant device

Within 30 sec after I2C test run => active D0/F0 state:
!fxdevice 0xffffaf8256372010
DevNode: 0xffffaf8251115aa0
UniqueId: "\_SB.I2C2"
InstancePath: "ACPI\NXP0104\2"
Device Power State: PowerDeviceD0
Component Count: 1
   Component 0: Current:F0/Deepest:F1 - IDLE (RefCount = 0)

After 30 sec after I2C test run => low power D3/F1 state:
```

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```
!fxdevice 0xffffaf8256372010
  DevNode: 0xffffaf8251115aa0
  UniqueId: "\_SB.I2C2"
  InstancePath: "ACPI\NXP0104\2"
  Device Power State: PowerDeviceD3
 Component Count: 1
   Component 0: Current:F1/Deepest:F1 - IDLE (RefCount = 0)
nt!DbgBreakPointWithStatus:
fffff803`43c08330 d43e0000 brk
                                                    #0xF000
0: kd> !fxdevice ffffaf82570e9aa0
 !fxdevice 0xffffaf82570e9aa0
 DevNode: 0xffffaf8251115aa0
 UniqueId: "\_SB.I2C2"
  InstancePath: "ACPI\NXP0104\2"
  Device Power State: PowerDeviceD3
  PEP Owner: Default PEP
  Acpi Plugin: 0
  Acpi Handle: 0
  Device Status Flags: DevicePowerNotRequired DeviceNotified
  DevicePowerNotRequired ReceivedFromPEP
  Device Idle Timeout: 0000000000
  Device Power On: No Activity
  Device Power Off: No Activity
  Device Unregister: No Activity
  Component Count: 1
   Component 0: Current:F1/Deepest:F1 - IDLE (RefCount = 0)
   Pep Component: 0xffffaf8256df24d0
    Active: 0 Latency: 0 Residency: 0 Wake: 0 Dx IRP: 0 WW IRP: 0
    Component Idle State Change: No Activity
    Component Activation: No Activity
    Component Active: No Activity
  Log has 25 entries starting at 0:
         IntTime CPU Cid
                                                 Tid
    0 00000076660627f 3 4 f0 Device registered with 1 component(s)
1 000000076660627f 3 4 f0 Start power management
2 000000076660627f 3 4 f0 Component 0 latency set to 8000001
3 000000076660627f 3 4 f0 Component 0 residency set to 12000000
4 000000766609e64 1 4 5c0 Component 0 changed to idle state F1
5 0000000766609e64 1 4 5c0 Power not required from default PEP
6 0000000766609e64 1 4 5c0 Power not required to device
7 0000000766609e64 2 4 ec Power TRP requested with status 0
                                             f0 Device registered with 1 component(s)
f0 Start power management
f0 Component 0 latency set to 8000001
f0 Component 0 residency set to 120000001
                                    2 2
    7 0000000766609e64
8 0000000766609e64
                                            4 ec Power IRP requested with status 0
4 ec Power IRP type D3 dispatched to device
  stack
   9 0000000766609e64
10 0000000766633b5a
11 0000000766633b5a
                                     3 4 e0 Device power state changed to D3
1 4 ec Power required from default PEP
1 4 ec Power required to device
   12 0000000766633b5a
                                    1
                                            4 ec Driver device power required callback
  pending
   13 000000766633b5a 1 4 ec Power IRP requested with status 0 14 0000000766633b5a 1 4 ec Power IRP type D0 dispatched to device
  stack
                                         4 4
  15 0000000766638961
16 0000000766638961
17 0000000766638961
                                     2
                                             4 b78 Device power state changed to D0
                                     2
                                                  b78
                                                         Device powered
                                    2
                                                  b78 Driver device power required callback
  completed
   18 0000000766638961
                                     3
                                            4
                                                   18 Component 0 changed to idle state F0
   19 00000076ddba246 0 4 18 Component 0 changed to idle state F1
```

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i.MX Windows 10 IoT User's Guide

20	000000076ddba246	0	4	18	Power not required from default PEP
21	000000076ddba246	0	4	18	Power not required to device
22	000000076ddba246	0	4	b78	Power IRP requested with status 0
23	000000076ddba246	0	4	b78	Power IRP type D3 dispatched to device
stack					
24	000000076ddba246	0	4	e0	Device power state changed to D3

5 Secure boot

5.1 Basic concepts

5.1.1

Secure Boot is a feature that prevents loading malicious pieces of software (rootkits) during the system boot. To perform a secure boot, the feature has to be supported by the whole boot chain, starting at the device ROM code and ending in Windows. For more information on how to prepare the board for Secure Boot, see Secure Provisioning.

For more detailed information on each platform, see:

- · Secure boot on i.MX 8M
- · Secure boot on i.MX 8QXP
- Secure boot on i.MX 93

5.2 Secure boot on i.MX 8M

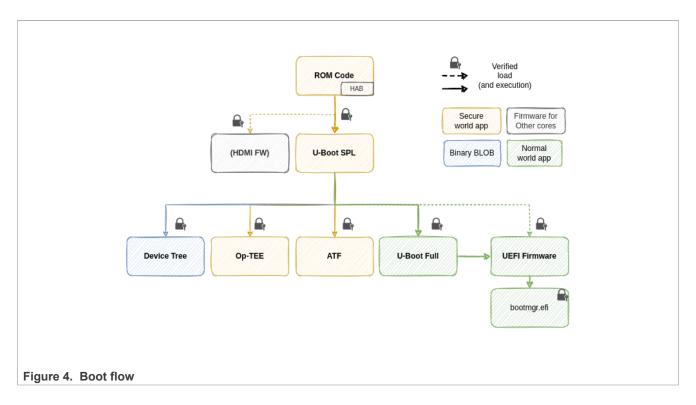
5.2.1 System boot on i.MX 8M

The boot process starts after device's power-on reset. The hardware logic forces the processor to start executing internal ROM code. Based on the state of the register BOOT_MODE [13:0] together with eFUSEs and GPIO pins (depends on configuration), the ROM code selects a boot device (Serial NOR Flash via FlexSPI, NAND flash, SD/MMC, Serial (SPI) NOR). The boot process then continues executing the code from the boot device. ROM searches Image Vector Table (IVT) on address, which is based on selected boot device. For example, 0×8400 for i.MX 8M Mini SD/eMMC boot. There it finds an entry point for code jump. For more details, see i.MX 8M Mini Applications Processor Reference Manual

5.2.2 System boot components

There are many software components involved in the boot process in order to run some complex operating system, including Windows. This project uses U-Boot SPL as the first stage bootloader (also called Secondary Program Loader, SPL). On i.MX 8M, the processor has a very limited access to peripherals when exiting ROM code area, since most of them are not initialized. Thus, the first stage bootloader has to be so small so it fits to system's on-chip RAM (OCRAM). Its main purpose is to initialize DDR in order to get access to full system memory and to load a proper second stage bootloader. The first stage boot loader and second stage boot loader are considered SoC/firmware boot loaders, whereas UEFI provides environment for Microsoft and OEMs.

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5.2.2.1 U-Boot SPL

This project uses <u>U-Boot SPL</u> as first-stage bootloader. The main purpose of U-Boot SPL is to initialize external memory, which is needed to run proper U-Boot. The U-Boot SPL loads a few more components that are participating in the configuration and security of the device - Device Tree blob, OP-TEE, and ARM Trusted firmware.

5.2.2.2 Device Tree Blob

Device Tree Blob (DTB) is a binary representation of <u>Device Tree</u>. Device Tree is a data format for description of system hardware in a format of tree of device nodes. The format is understood (and required) for example, by U-Boot proper and Linux kernel. Thanks to Device Tree, a single program binary can support multiple platforms, just by changing DTB that is used.

5.2.2.3 OP-TEE

Open Portable Trusted Execution Environment (OP-TEE) is an opensource implementation of Trusted Execution Environment using ARM Trust Zone technology. It provides a way of running applications within secure world. This project uses OP-TEE as runtime environment for fTPM and Authenticated Variables.

5.2.2.4 ATF

ARM Trusted Firmware is an implementation of firmware running with elevated privileges (EL3) and is used mostly as a proxy between the OS running in non-secure world and OP-TEE running in secure world.

5.2.2.5 U-Boot proper

The <u>U-Boot</u> proper is used in this project to perform early display initialization and load the UEFI bootloader. When enabled (disabled by default), the U-Boot provides powerful CLI interface and can serve as a tool for device provisioning and/or debugging.

5.2.2.6 UEFI

The Unified Extensible Firmware Interface (UEFI) is a specification defining a unified interface between the firmware and the OS. UEFI firmware does the rest of the initialization and hands off the control to Windows Boot Manager.

For more details, see Boot and UEFI.

5.2.3 Ensuring firmware security

To ensure integrity and to prove genuinity of all boot components, they need to be signed, and the validity of the digital signature must be verified before passing the control to the next stage of the boot.

5.2.3.1 Security configuration

The reaction of the chip on various security events is massively dependent on its security configuration, which may be affected by several fuses and <u>HAB</u>.

5.2.3.1.1 Open/Closed

The open/closed state determines whether SECO allows execution of unauthenticated program images. Open chip allows execution of any program image - unauthenticated images and authenticated images with bad signature. Closed chip allows only execution of authenticated images. The state is defined by the SEC CONFIG[1:0] eFUSE:

Table 1. Fuse values and effect

Fuse value	Effect		
00	Reserved		
01	Open		
1x	Closed		

5.2.3.1.2 SRKH

The Super Root Key Hash (SRKH) is a set of 8 eFUSES that contain combined hash of hashes of particular Super Root Keys. Those are one of main components of the HAB chain of trust.

5.2.3.2 Bootloader verification chain

All firmware signatures are generated at build time using private keys from the HAB chain of trust.

- 1. ROM Code verifies U-Boot SPL
- 2. U-Boot SPL checks Device Tree Blob, ATF, OP-TEE, U-Boot proper, and UEFI
- 3. UEFI checks efi modules and Windows Boot Manager

ROM code cannot be changed and is considered trusted. To verify the signature of SPL, the ROM contains a module called High Assurance Boot.

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HAB is a software component responsible for verifying digital signatures. Its API is available to external applications via ROM vector table (RVT). Before jumping to SPL, ROM verifies the signature of SPL. Only a valid SPL signature allows boot flow to proceed (see Chip lifecycle).

Once loaded and verified, **U-Boot SPL** is also considered secure and trusted. U-Boot SPL loads container image containing <u>Device Tree Blob</u>, <u>ATF</u>, <u>OP-TEE</u>, <u>U-Boot proper</u> and <u>UEFI</u>. When building with -t secured_efi, the U-Boot SPL verifies signature of each component of the FIT image. The U-Boot SPL will proceed to proper U-Boot only with the matching signature. The verification is realized by HAB module.

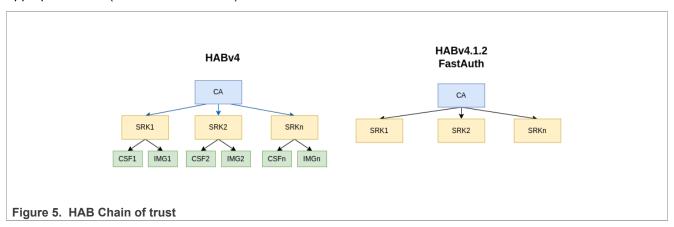
5.2.3.3 HAB Chain of trust

HAB Chain of trust is a set of certificates and keys, forming Public Key Infrastructure (PKI) used for signing and verification of Secure Boot components handled by HAB. This repository contains a pre-generated PKI. To use your own PKI, point the environment variable KEY ROOT to your key root folder.

Important: Building BSP with default KEY_ROOT produces signed, but insecure binaries since they are signed with well-known keys!

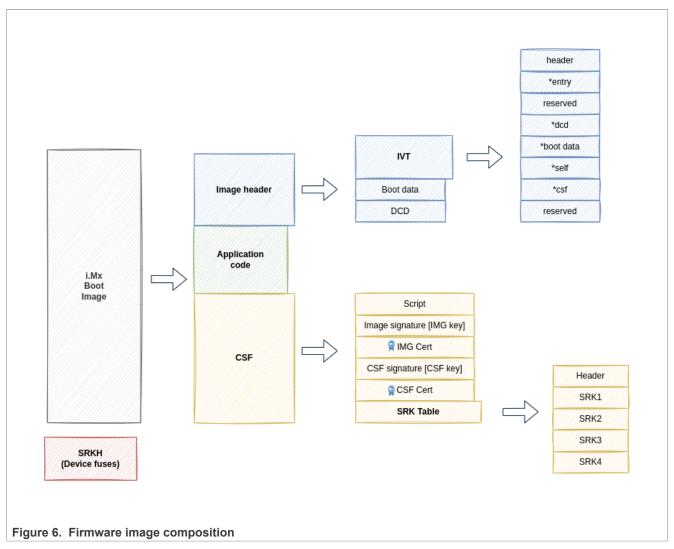
NXP provides a set of tools, called CST that helps with generating custom PKI and signing.

The HAB Chain of Trust consists of single Certification Authority (CA), four Super Root Keys (SRK) and (optionally) four image (IMG) keys and command sequence file (CSF) keys. Depending on HAB version, firmware images and CSFs can be signed directly by SRK (HABv4) or by IMG and CSF keys that are signed by appropriate SRK (HABv4.1.2 FastAuth).



5.2.3.4 i.MX Firmware image verification

Even though the SECO (AHAB) is responsible for signature verification, the verification key itself cannot be burned to eFUSES since there are not enough of them. To circumvent that, only a footprint of the key is written to the device. The verification key itself is then packed along the signature to the firmware binary. HAB then verifies the key against the footprint and uses the key to verify the signature. This information is stored in the CSF block, see Figure 6



When HAB verifies the signature of i.MX firmware image, the steps as as follows:

- 1. Get the CSF location from IVT.
- 2. Extract the SRK table from CSF.
- 3. Compute SRKH and verify against fuses. Break if invalid.
- 4. Verify the CSF and IMG certificates by appropriate SRK from the SRK table. Break if invalid.
- 5. Verify the CSF signature and the image signature.

5.3 Secure boot on i.MX 8QXP

5.3.1 System boot on i.MX 8QXP

Compared to i.MX 8M, where the system boots from ARM Cortex-A cores from ROM memory, i.MX 8QXP starts its boot in dedicated security subsystem (SECO) and a system control unit (SCU). They are separate ARM Cortex-M cores that run their own code, starting in their respective ROMs. During the boot process, there is a firmware downloaded for each of these cores, where their program flow continues. Then, firmware for other system cores is loaded. SCU ROM code selects boot device (SD/MMC, NAND flash, FlexSPI NOR flash, Serial downloader on USB) based on SCU BOOT MODE pins and Force Boot From Fuse efuse. The first stage

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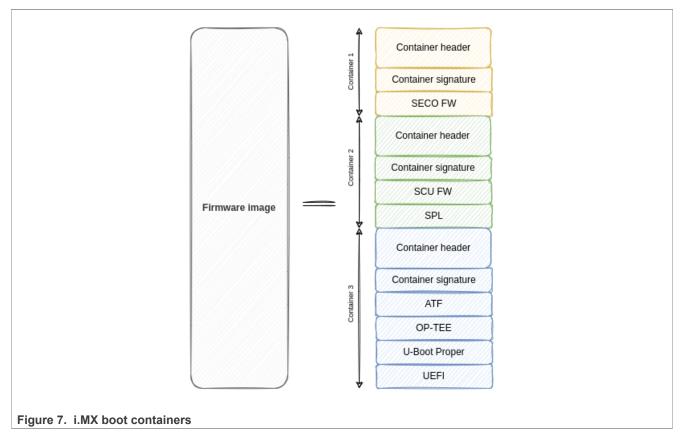
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bootloader for application cores may then be loaded directly to RAM (compared to i.MX 8M, which needs an SPL, that will fit into OCRAM and set up the DDR first).

For more details, see chapter 5.5 Secure Boot Flow with SCU and SECO in <u>i.MX</u> <u>DualX/8DualXPlus/8QuadXPlus Applications Processor Reference Manual</u>

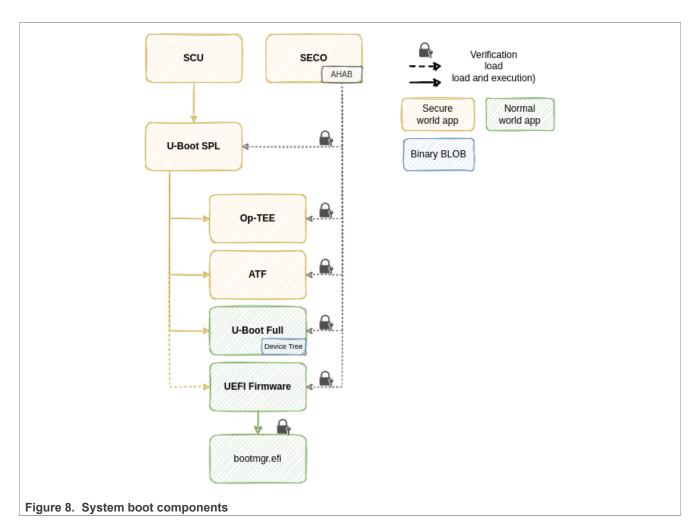
5.3.2 i.MX boot containers

Application images that participate in i.MX 8QXP system boot are packed into so-called containers and there **at least** two of them in order to boot the board. The first one is provided and signed by NXP and contains SECO FW. The second one contains SCU FW and application code for other cores. Each container consists of the container header, the container signature block (may be empty) and one or more images. Each image has its own header, which defines load address and entry point. Containers are composed using the imx-mkimage tool.



5.3.3 System boot components

There are many software components involved in the boot process to run some complex operating systems, including Windows. This project uses U-Boot SPL as the first-stage bootloader (also called Secondary Program Loader, SPL). The first-stage boot loader and second-stage boot loader are considered SoC/firmware boot loaders, whereas UEFI provides environment for Microsoft and OEMs.



5.3.3.1 U-Boot SPL

This project uses <u>U-Boot SPL</u> as the first-stage bootloader. The main purpose of U-Boot SPL is to initialize external memory, which is needed in order to run proper U-Boot. The U-Boot SPL actually loads a few more components that are participating on the configuration and security of the device - Device Tree blob, OP-TEE, and ARM Trusted firmware.

5.3.3.2 Device Tree Blob

Device Tree Blob (DTB) is a binary representation of <u>Device Tree</u>. Device Tree is a data format for description of system hardware in a format of tree of device nodes. The format is understood (and required) for example, by U-Boot proper and Linux kernel. Thanks to Device Tree, a single program binary can support multiple platforms, just by changing DTB that is used.

5.3.3.3 OP-TEE

Open Portable Trusted Execution Environment (OP-TEE) is an opensource implementation of Trusted Execution Environment using ARM Trust Zone technology. It provides a way of running applications within secure world. This project uses OP-TEE as runtime environment for fTPM and Authenticated Variables.

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5.3.3.4 ATF

ARM Trusted Firmware is an implementation of firmware running with elevated privileges (EL3) and is used mostly as a proxy between the OS running in non-secure world and OP-TEE running in secure world.

5.3.3.5 U-Boot proper

The <u>U-Boot</u> proper is used in this project to perform early display initialization and load the UEFI bootloader. When enabled (disabled by default), the U-Boot provides powerful CLI interface and can serve as a tool for device provisioning and/or debugging.

5.3.3.6 UEFI

The Unified Extensible Firmware Interface (UEFI) is a specification defining a unified interface between the firmware and the OS. UEFI firmware does the rest of the initialization and hands off the control to Windows Boot Manager.

For more details, see Boot and UEFI.

5.3.4 Ensuring firmware security

To ensure integrity and to prove genuinity of all boot components, they need to be signed, and the validity of the digital signature must be verified before passing the control to the next stage of the boot.

5.3.4.1 Security configuration

The reaction of the chip on various security events is massively dependent on its security configuration, which may be affected by several fuses and SECO.

5.3.4.1.1 Open/Closed

The open/closed state determines whether SECO allows the execution of unauthenticated program images. The open chip allows the execution of any program image - unauthenticated images and authenticated images with bad signatures. A closed chip allows only the execution of authenticated images. The state can be controlled, for example, from U-Boot cli via the `ahab_status` command. The status can be either `NXP closed` (open) or `OEM closed` (closed).

Example:

```
=> ahab_status
Lifecycle: 0x0020, NXP closed
```

5.3.4.1.2 SRKH

The Super Root Key Hash (SRKH) is a set of 16 eFUSES (on i.MX 8QXP) that contain a combined hash of hashes of particular Super Root Keys. They are one of the main components of the <u>Advanced High Assurance Boot (AHAB) chain of trust.</u>

5.3.4.2 Bootloader verification chain

All firmware signatures are generated at build time using private keys from the AHAB chain of trust.

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- 1. SECO verifies Container 1 (SECO FW) and Container 2 (SCU FW+SPL)
- 2. SPL checks Container 3 (ATF, OP-TEE, U-Boot proper, and UEFI)
- 3. UEFI checks efi modules and Windows Boot Manager

SCU and SECO **ROM code** cannot be changed and is considered trusted. To verify the signature of SPL, the SCU relies on SECO FW, which does the signature check via its AHAB module. When the chip is closed, only a valid SPL signature allows boot flow to proceed (see Chip lifecycle). Once loaded and verified, **U-Boot SPL** is also considered secure and trusted. U-Boot SPL loads container image containing <u>Device Tree Blob</u>, <u>ATF</u>, <u>OP-TEE</u>, <u>U-Boot proper</u> and <u>UEFI</u>. When building with -t secured_efi, the U-Boot SPL verifies the signature of each component of the FIT image. The U-Boot SPL proceeds to the proper U-Boot only when a matching signature is present. The SPL requests signature verification from SECO AHAB.

U-Boot proper asks SECO for signature verification of UEFI firmware. The binary was already checked by SPL since it is a part of the container that is loaded by SPL, however, U-Boot currently does not support partial signature checking (enabled in SPL, but disabled in U-Boot proper). The U-Boot proper hands off the control to UEFI.

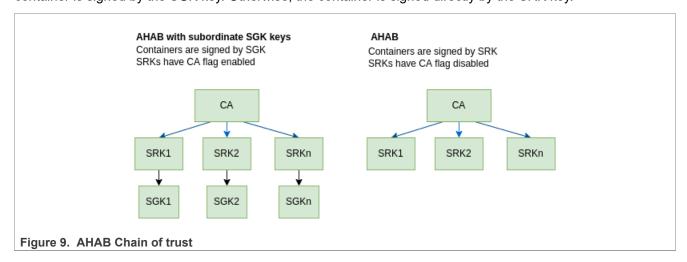
5.3.4.3 AHAB Chain of trust

AHAB Chain of trust is a set of certificates and keys, forming Public Key Infrastructure (PKI) used for signing and verification of Secure Boot components handled by AHAB. This repository contains a pre-generated PKI. To use your own PKI, point environment variable KEY ROOT to your key root folder.

Important: Building BSP with default KEY_ROOT will produce signed, but not secure binaries since they are signed with well-known keys!

NXP provides a set of tools, called CST that helps with generating custom PKI and signing.

The AHAB Chain of Trust consists of single Certification Authority (CA), four Super Root Keys (SRK) and (optionally) four subordinate (SGK) keys. When using SGK keys (SRK generated with CA flag set), the firmware container is signed by the SGK key. Otherwise, the container is signed directly by the SRK key.



5.3.4.4 i.MX Firmware image verification

Even though the SECO (AHAB) is responsible for signature verification, the verification key itself cannot be burned to eFUSES since there are not enough of them. To circumvent that, only a footprint of the key is written to the device. The verification key itself is then packed along with the signature to the firmware binary. SECO then verifies the key against the footprint and then uses the key to verify the signature.

When SECO verifies the signature of the i.MX firmware image, it does the following:

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- 1. Get the SRK table location from the container signature header.
- 2. Extract the SRK table.
- 3. Compute SRKH and verify against fuses. Break if invalid.
- 4. (optional) Verify the SGK certificate by an appropriate SRK from the SRK table. Break if invalid.
- 5. Verify the container signature.

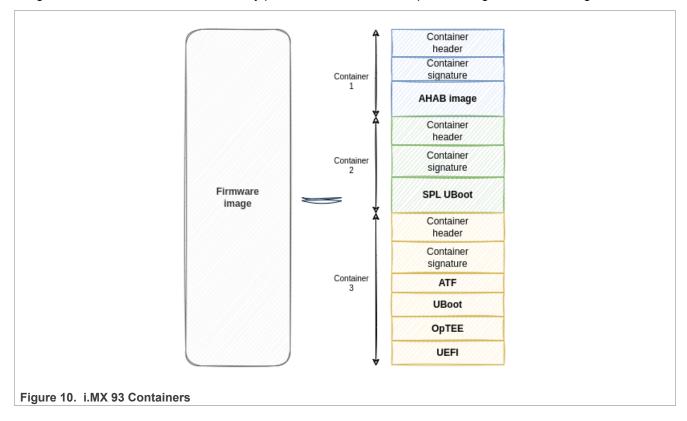
5.4 Secure boot on i.MX 93

5.4.1 System boot on i.MX 93

i.MX 93 boots from on-chip ROM code. Based on various fuse values and boot switches, the ROM selects the proper boot medium and flow. Secure aspects of platform boot are handled by EdgeLock secure enclave ROM (ELE). The boot ROM contains Advanced High Assurance Boot (AHAB) library that enables secure boot functionality, with ELE as a backend. For more details, see chapter 8.1 Single Boot Flow (Cortex-A55) in i.MX 93 Applications Processor Reference Manual.

5.4.2 i.MX Boot Containers

Application images that participate in i.MX 93 system boot are packed into so-called images and containers. A boot container may contain one or more boot images (A55 image, M33 image, and ELE FW). Each container consists of the container header, the container signature block (may be empty), and one or more images. Each image has its own load address and entry point. Containers are composed using the `imx-mkimage` tool.

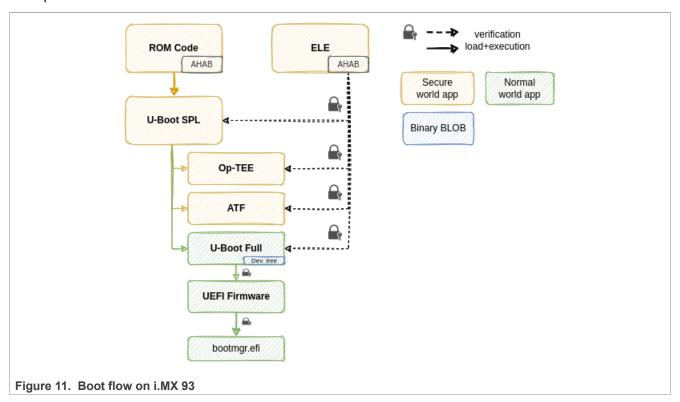


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5.4.3 System boot components

There are many software components involved in the boot process to run some complex operating systems, including Windows. This project uses U-Boot SPL as the first stage bootloader (also called Secondary Program Loader, SPL).

The first-stage boot loader and second-stage boot loader are considered SoC/firmware boot loaders, whereas UEFI provides an environment for Microsoft and OEMs.



5.4.3.1 U-Boot SPL

This project uses U-Boot SPL as the first stage bootloader. Compared to i.MX 8M, the SPL has access to full system memory. The purpose of SPL on i.MX 93 is to load other firmware components to non-continuous memory. The SPL understands i.MX container format and loads the following components that are participating in the configuration and security of the device to their respective load addresses: OP-TEE, ARM Trusted firmware, U-Boot proper, and UEFI firmware.

5.4.3.2 Device Tree Blob

Device Tree Blob (DTB) is a binary representation of <u>Device Tree</u>. Device Tree is a data format for description of system hardware in a format of tree of device nodes. The format is understood (and required) for example, by U-Boot proper and Linux kernel. Thanks to Device Tree, a single program binary can support multiple platforms, just by changing DTB that is used.

5.4.3.3 OP-TEE

Open Portable Trusted Execution Environment (OP-TEE) is an opensource implementation of Trusted Execution Environment using ARM Trust Zone technology. It provides a way of running applications within secure world. This project uses OP-TEE as runtime environment for fTPM and Authenticated Variables.

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5.4.3.4 ATF

ARM Trusted Firmware is an implementation of firmware running with elevated privileges (EL3) and is used mostly as a proxy between the OS running in non-secure world and OP-TEE running in secure world.

5.4.3.5 U-Boot proper

The <u>U-Boot</u> proper is used in this project to perform early display initialization and load the UEFI bootloader. When enabled (disabled by default), the U-Boot provides powerful CLI interface and can serve as a tool for device provisioning and/or debugging.

5.4.3.6 UEFI

The Unified Extensible Firmware Interface (UEFI) is a specification defining a unified interface between the firmware and the OS. UEFI firmware does the rest of the initialization and hands off the control to Windows Boot Manager.

For more details, see Boot and UEFI.

5.4.4 Ensuring firmware security

To ensure integrity and to prove genuinity of all boot components, they need to be signed, and the validity of the digital signature must be verified before passing the control to the next stage of the boot.

5.4.4.1 Security configuration

The reaction of the chip on various security events is massively dependent on its security configuration, which may be affected by several fuses and ELE.

5.4.4.1.1 Open/Closed

The open/closed state determines whether AHAB allows the execution of unauthenticated program images. The open chip allows the execution of any program image - unauthenticated images and authenticated images with bad signatures. A closed chip allows only the execution of authenticated images. The state can be controlled, for example, from U-Boot cli via the `ahab_status` command. The status can be either `NXP closed` (open) or `OEM closed` (closed).

Example:

```
=> ahab_status
Lifecycle: 0x0020, NXP closed
```

5.4.4.1.2 SRKH

The Super Root Key Hash (SRKH) on i.MX 93 is the SHA256 hash of the SRK table. The SRKH is stored in a set of 8 32-bit eFUSES that contain the hash of the SRK table, containing Super Root Keys. Those are one of the main components of the <u>Advanced High Assurance Boot (AHAB) chain of trust</u>.

5.4.4.2 Bootloader verification chain

All firmware signatures are generated at build time using private keys from AHAB chain of trust.

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- 1. ELE verifies Container 1 (AHAB) and Container 2 (SPL)
- 2. SPL checks Container 3 (ATF, OP-TEE, U-Boot proper, and UEFI)
- 3. UEFI checks efi modules and Windows Boot Manager

ROM code cannot be changed and is considered trusted. To verify the signature of SPL, the ROM relies on ELE, which does the signature check via its AHAB module. When the chip is closed, only a valid SPL signature allows boot flow to proceed (see Chip lifecycle). Once loaded and verified, **U-Boot SPL** is also considered secure and trusted. U-Boot SPL loads container image containing Device Tree Blob, ATF, OP-TEE, <a href="U-Boot U-Boot SPL verifies the signature of each component of the FIT image. The U-Boot SPL proceeds to the proper U-Boot only when a matching signature is present. The SPL requests signature verification from ELE/AHAB.

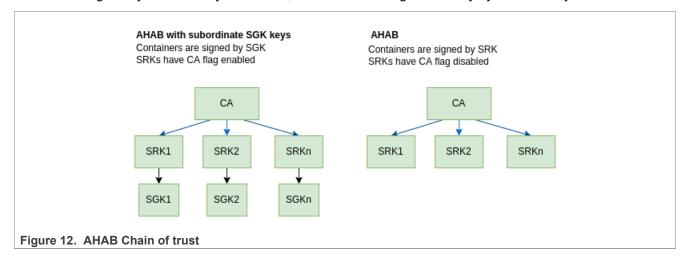
5.4.4.3 AHAB Chain of trust

AHAB Chain of trust is a set of certificates and keys, forming Public Key Infrastructure (PKI) used for signing and verification of Secure Boot components handled by AHAB. This repository contains a pre-generated PKI. To use your own PKI, point environment variable KEY_ROOT to your key root folder.

Important: Building BSP with default KEY_ROOT will produce signed, but not secure binaries since they are signed with well-known keys!

NXP provides a set of tools, called CST that helps with generating custom PKI and signing.

The AHAB Chain of Trust consists of single Certification Authority (CA), four Super Root Keys (SRK) and (optionally) four subordinate (SGK) keys. When using SGK keys (SRK generated with CA flag set), the firmware container is signed by the SGK key. Otherwise, the container is signed directly by the SRK key.



5.4.4.4 i.MX Firmware image verification

Even though the ELE (AHAB) is responsible for signature verification, the verification key itself cannot be burned to eFUSES since there are not enough of them. To circumvent that, only a footprint of the key is written to the device. The verification key itself is then packed along with the signature to the firmware binary. ELE then verifies the key against the footprint and then uses the key to verify the signature.

When ELE verifies the signature of the i.MX firmware image, it does the following:

- 1. Get the SRK table location from the container signature header.
- 2. Extract the SRK table.
- 3. Compute SRKH and verify against fuses. Break if invalid.
- 4. (optional) Verify the SGK certificate by an appropriate SRK from the SRK table. Break if invalid.

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5. Verify container signature.

5.5 Secure storage

There is numerous sensitive information in the system, that must be stored securely - credentials, cryptographic keys, and so on. They may be both volatile and non-volatile and must be hidden not only from other applications running under Windows, but also from other operating systems and peripherals. One example is Authenticated Variables (AuthVars) functionality, described in the UEFI specification. This mechanism is used for storing sensitive system data. Only authenticated issuer may read and modify these data. AuthVars are also used for storing UEFI provisioning data (PK,KEK,db,dbx).

5.5.1 RPMB

This repository uses Replay Protected Memory Block (as defined in JEDEC eMMC specification JESD84-B51) as a secure storage backend. RPMB is a special partition on eMMC memory where every read or write operation must be authenticated. RPMB access is replay protected in a way, that every operation contains a signature (MAC), that contains an incremental write counter. The signature is generated using a symmetric key, that is burned in the eMMC controller and must be known also by issuer of the command. The process of writing the key to eMMC controller is a one-way process and the key is written in plaintext, it therefore must be done in a secure environment.

RPMB is mandatory for this system to work since it is used as a secure storage backend for OP-TEE (and OP-TEE is used by UEFI for storing AuthVars). For more information on how OP-TEE uses RPMB, see the following link

5.5.2 Secure vs. non-secure build

The firmware binary can be built in two setups based on flags passed to the buildme64.sh script:

- Secure build when building with -t secured efi or -t secured uefi
- Non-Secure build when building without t secured efi or -t secured uefi

Note: The effect of -t secured_efi is identical to -t secured_uefi, both parameters are interchangeable.

5.5.2.1 Secure build

Secure build provides secure binaries with all Secure Boot dependencies enabled. UEFI firmware is built with support of Secure Boot and AuthVars and Measured Boot is enabled. All firmware binaries are signed during the build (U-Boot SPL, DT, OP-TEE, ATF, U-Boot, UEFI) and signature checks in U-Boot SPL are enforced.

Note: Secure firmware binary will not boot on clean device. To boot secure firmware binary, the RPMB key must be already present in the eMMC controller. Otherwise, the initialization of OP-TEE and all dependencies will fail. For more information, see Secure provisioning.

5.5.2.2 Non-Secure build

Non-secure build provides an easy way for testing and prototyping. In this setup, firmware binaries are not signed and SPL signature checks are disabled. The Secure Boot, AuthVars, and Measured Boot are disabled.

This setup boots even without RPMB key provisioned (for example, a new device).

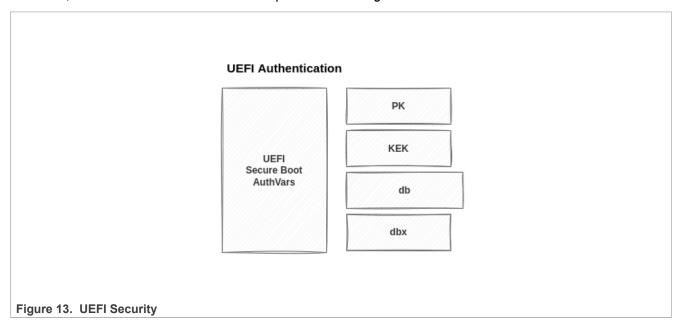
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5.6 Secure Boot in UEFI and Windows

UEFI and Windows use their own chain of trust, which is composed of Platform Key (PK), Key Exchange Key (KEK), forbidden signature database (dbx) and valid signature database (db). Those credentials are stored as UEFI Secure variables. Those variables must be programmed at OEM site.

Important: Even when building with -t secured_efi, the boot chain is not fully secured until PK is written. Until then, the UEFI and Windows are in setup mode where signatures are not checked.



6 Secure provisioning

To achieve full system security with Secure Boot, the following steps must be performed in the correct order:

- 1. Prepare keys for HAB/AHAB.
- 2. Lock the device (burn SRKH and SEC CONFIG fuses).
- 3. Write the RPMB key.
- 4. Boot the device and load UEFI keys.

There are many ways to generate HAB/AHAB keys, you are free to provide your own way of generating those. This guide presents a simple way using $\underline{\texttt{CST}}$ toolset. After download, see User Guide in $< \texttt{cst_directory} > / \texttt{docs/CST_UG.pdf.}$

For detailed steps, follow device-specific guides:

<u>i.MX 8M</u>

i.MX 8QXP

i.MX 93

6.1 Secure provisioning i.MX 8M

These steps are only applicable for i.MX 8M family. Use an appropriate <u>guide</u> for your platform otherwise you risk bricking your device.

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6.1.1 Generate HAB keys

Generate the PKI using the $keys/hab4_pki_tree.sh$ script, use the following options to generate four p256 ECC SRK and four IMG and CSF keys.

```
cd <cst_directory>/keys
./hab4_pki_tree.sh
Do you want to use an existing CA key (y/n)?: n
Do you want to use Elliptic Curve Cryptography (y/n)?: y
Enter length for elliptic curve to be used for PKI tree:
Possible values p256, p384, p521: p256
Enter PKI tree duration (years): 10
How many Super Root Keys should be generated? 4
Do you want the SRK certificates to have the CA flag set? (y/n)?: n
```

The script populates keys and crts folders within CST root folder with private keys and appropriate certificates. Set KEY_ROOT environment variable to absolute path to CST root folder (the folder containing keys and crts sub-folders).

```
export KEY_ROOT=<cst_directory>
```

Build will automatically fetch keys and certificates from this path to sign firmware binaries.

6.1.1.1 Prepare SRK table

CST provides srktool to prepare the SRK table. SRKH values that must be written to fuses.

```
cd <cst_directory>/crts
../linux64/bin/srktool -h 4 -t SRK_14table.bin -e SRK_fuse.bin -d sha256 -c
./SRK1_sha256_4096_65537_v3_ca_crt.pem,./SRK2_sha256_4096_65537_v3_ca_crt.pem,./
SRK3_sha256_4096_65537_v3_ca_crt.pem,./SRK4_sha256_4096_65537_v3_ca_crt.pem
-f 1
```

The program prints out a summary with results:

```
Number of certificates = 4

SRK table binary filename = SRK_14table.bin

SRK Fuse binary filename = SRK_fuse.bin

SRK Fuse binary dump:

SRK HASH[0] = 0x17B73726

SRK HASH[1] = 0x8E5CCC0E

SRK HASH[2] = 0xBC30A7BE

SRK HASH[3] = 0xE9B59C78

SRK HASH[4] = 0x2C682DAE

SRK HASH[5] = 0xDE5FE6C0

SRK HASH[6] = 0x3FF3DC81

SRK HASH[7] = 0x44B5B6FE
```

The SRK HASH[] array contains the SRKH value divided by four bytes. These are the values that are written to SRK_HASH eFUSE in the next step.

For more information on how to use srktool, see chapter 3.1.3 Generating HAB4 SRK tables and Efuse Hash in <cst directory>/docs/CST UG.pdf

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6.1.2 Building secured binary

With HAB/AHAB keys prepared, you are able to build a signed secure binary. Build the firmware with -t secured efi or -t secured uefi flag enabled, for example:

```
./buildme64.sh -b 8Mm -t all -t secured efi -nu
```

The command above produces win10-iot-bsp/imx-windows-iot/BSP/firmware/MX8M_MINI_EVK/signed flash.bin, which is a signed binary image containing all boot components.

6.1.3 Locking the device for i.MX 8M

Warning: Steps described in this section are irreversible. Always make sure you know what you are doing, any misconfiguration may lead to a bricked device.

This guide uses U-Boot's commandline interface as a tool for burning eFUSES.

6.1.4 Burning SRK_HASH

- 1. Load a stock image to the SD card (non-secure build).
- 2. Enter U-Boot command-line interface (press escape on prompt during boot).
- 3. To find proper fuse indexes, see the fuse map for your device.
- 4. Burn SRK_HASH fuses with values from srktool see SRK_fuse.bin. Use the output values of srktool or use the following command: hexdump -e '/4 "0x"' -e '/4 "%X""\n"' < SRK fuse.bin

Example for i.MX 8M Mini:

```
fuse prog -y 6 0 0x17B73726

fuse prog -y 6 1 0x8E5CCC0E

fuse prog -y 6 2 0xBC30A7BE

fuse prog -y 6 3 0xE9B59C78

fuse prog -y 7 0 0x2C682DAE

fuse prog -y 7 1 0xDE5FE6C0

fuse prog -y 7 2 0x3FF3DC81

fuse prog -y 7 3 0x44B5B6FE

reset
```

The device now contains an SRK Hash composed of your PKI keys and is able to verify firmware binary signatures. Until locked, the device still accepts unsigned binaries and binaries with bad signature.

Tip: Before locking the chip, boot a signed image from the step Building secured binary and check HAB events:

- 1. Prepare an SD card with secured binary.
- 2. Enter U-Boot command line.
- 3. Enter the hab status command.

The command should output following text, saying that all signatures are valid:

```
Secure boot enabled
HAB Configuration: 0xcc, HAB State: 0x99
No HAB Events Found!
```

6.1.5 Burning SEC_CONFIG

- 1. Load stock image to SD card (non-secure build).
- 2. Enter U-Boot command-line interface (press escape on prompt during boot).
- 3. To find proper fuse indexes, see fuse map for your device.

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4. Burn the SEC CONFIG fuse to achieve the "closed" state.

Example for i.MX 8M Mini:

```
fuse prog 1 3 0x02000000 reset
```

The chip is now locked and accepts only firmware signed with appropriate keys.

6.2 Secure provisioning i.MX 8QXP

These steps are only applicable for i.MX 8QXP family. Use an appropriate <u>guide</u> for your platform otherwise you risk bricking your device.

6.2.1 Generate AHAB keys

This section presents a way of generating AHAB keys. They are only applicable for i.MX 8QXP and i.MX 93 SoC.

Start by running the keys/ahab_pki_tree.sh script, use the following options to generate four p384 ECC SRK with CA flag disabled (SRK used for container signing).

```
cd <cst_directory>/keys
./ahab_pki_tree.sh
Do you want to use an existing CA key (y/n)?: n
Do you want to use Elliptic Curve Cryptography (y/n)?: y
Enter length for elliptic curve to be used for PKI tree:
Possible values p256, p384, p521: p384
Enter the digest algorithm to use: sha384
Enter PKI tree duration (years): 5
Do you want the SRK certificates to have the CA flag set? (y/n)?: n
```

The script populates keys and crts folders within the CST root folder with private keys and appropriate certificates. Set the KEY_ROOT environment variable to absolute path to CST root folder (the folder containing keys and crts subfolders).

```
export KEY_ROOT=<cst_directory>
```

Build automatically fetches keys and certificates from this path to sign firmware binaries.

6.2.1.1 Prepare SRK table

CST provides srktool to prepare the SRK table. SRKH values that must be written to fuses.

```
cd <cst_directory>/crts
../linux64/bin/srktool -a -s sha384 -t SRKtable.bin -e SRKfuse.bin -f 1 -c
SRK1_sha384_secp384r1_v3_usr_crt.pem, SRK2_sha384_secp384r1_v3_usr_crt.pem, SRK3_sha384_secp
```

The program prints a summary with results:

```
Number of certificates = 4

SRK table binary filename = SRKtable.bin

SRK Fuse binary filename = SRKfuse.bin

SRK Fuse binary dump:

SRK HASH[0] = 0x336D1608

SRK HASH[1] = 0xDFCC2D5E
```

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```
SRK HASH[2] = 0xB582FA14

SRK HASH[3] = 0xDA325A05

SRK HASH[4] = 0xEAB66EDE

SRK HASH[5] = 0xB64F7A87

SRK HASH[6] = 0xC9CAD3BF

SRK HASH[7] = 0x479DC210

SRK HASH[8] = 0x79DA681C

SRK HASH[9] = 0x8C55E093

SRK HASH[10] = 0x3CF9CF19

SRK HASH[11] = 0xC7B6DDF0

SRK HASH[12] = 0xE0C3363E

SRK HASH[13] = 0x73D8A971

SRK HASH[14] = 0x240A0EEE

SRK HASH[15] = 0xE46CE431
```

The SRK HASH[] array contains the SRKH value divided by four bytes. These are the values that will be written to SRK_HASH eFUSE in the next step (applicable only for i.MX 8QXP)

For more information on how to use srktool, see chapter 3.2.3 Generating AHAB SRK tables and Efuse Hash in <cst_directory>/docs/CST_UG.pdf

6.2.2 Building secured binary

With HAB/AHAB keys prepared, you are able to build a signed secure binary. Build the firmware with -t secured efi or -t secured uefi flag enabled, for example:

```
./buildme64.sh -b 8Mm -t all -t secured efi -nu
```

The command above produces win10-iot-bsp/imx-windows-iot/BSP/firmware/MX8M_MINI_EVK/signed flash.bin, which is a signed binary image containing all boot components.

6.2.3 Locking the device (i.MX 8QXP)

Warning: CAUTION: Steps described in this section are irreversible. Always make sure you know what you are doing, any misconfiguration may lead to bricked device.

The following steps are only applicable for i.MX 8QXP and i.MX 93 SoC. For i.MX 8M, see section Locking the device (i.MX 8M) above.

This guide uses U-Boot's commandline interface as a tool for burning eFUSES.

6.2.3.1 Burning SRK_HASH

- 1. Load a stock image to the SD card.
- 2. Enter U-Boot command-line interface (press escape on prompt during boot).
- 3. To find proper fuse indexes, see fuse map for your device.
- 4. Burn SRK_HASH fuses with values from srktool see SRK_fuse.bin. Use the output values of srktool or use following command: hexdump -e '/4 "0x"' -e '/4 "%X""\n"' < SRKfuse.bin

```
# For i.MX 8QXP only
# Dump SRKH to console
hexdump -e '/4 "0x"' -e '/4 "%X""\n"' < SRKfuse.bin
0x336D1608
0xDFCC2D5E
0xB582FA14
0xDA325A05
0xEAB66EDE
0xB64F7A87
```

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i.MX Windows 10 IoT User's Guide

```
0xC9CAD3BF

0x479DC210

0x79DA681C

0x8C55E093

0x3CF9CF19

0xC7B6DDF0

0xE0C3363E

0x73D8A971

0x240A0EEE

0xE46CE431
```

```
# For i.MX 8QXP only
# Write values to fuses via UBoot CLI
fuse prog 0 730 0x336d1608
fuse prog 0 731 0xdfcc2d5e
fuse prog 0 732 0xb582fa14
fuse prog 0 733 0xda325a05
fuse prog 0 734 0xeab66ede
fuse prog 0 735 0xb64f7a87
fuse prog 0 736 0xc9cad3bf
fuse prog 0 737 0x479dc210
fuse prog 0 738 0x79da681c
fuse prog 0 739 0x8c55e093
fuse prog 0 740 0x3cf9cf19
fuse prog 0 741 0xc7b6ddf0
fuse prog 0 742 0xe0c3363e
fuse prog 0 743 0x73d8a971
fuse prog 0 744 0x240a0eee
fuse prog 0 745 0xe46ce431
reset
```

The device now contains an SRK Hash composed of your PKI keys and is able to verify firmware binary signatures. Until locked, the device still accepts unsigned binaries and binaries with bad signature.

Tip: Before locking the chip, boot a signed image from the step <u>Building secured binary</u> and check AHAB events:

- 1. Prepare the SD card with secured binary.
- 2. Enter U-Boot command line.
- 3. Enter the ahab status command.

The command should output following text, indicating that all signatures are valid:

```
=> ahab_status
Lifecycle: 0x0020, NXP closed
No SECO Events Found!
```

In case of any error, U-Boot prints out and parse SECO events. Example for a missing signature:

```
=> ahab_status
Lifecycle: 0x0020, NXP closed
SECO Event[0] = 0x0087EE00

CMD = AHAB_AUTH_CONTAINER_REQ (0x87)
IND = AHAB_NO_AUTHENTICATION_IND (0xEE)
```

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6.2.3.2 Closing the chip

- 1. Load a stock image to the SD card (non-secure build).
- 2. Enter U-Boot command-line interface (press escape on prompt during boot).
- 3. Close the chip and reboot.

Example:

```
=> ahab_close
=> reset
```

The chip is now locked and accepts only firmware signed with appropriate keys. You can check that via ahab status command, the lifecycle must be 0x80 OEM closed.

```
=> ahab_status
Lifecycle: `0x80, OEM closed`
```

6.3 Secure provisioning i.MX 93

These steps are only applicable for i.MX 93 family. Use an appropriate <u>guide</u> for your platform otherwise you risk bricking your device.

6.3.1 Generate AHAB keys

This section presents a way of generating AHAB keys. They are only applicable for i.MX 8QXP and i.MX 93 SoC.

Start by running the keys/ahab_pki_tree.sh script, use the following options to generate four p384 ECC SRK with CA flag disabled (SRK used for container signing).

```
cd <cst_directory>/keys
./ahab_pki_tree.sh
Do you want to use an existing CA key (y/n)?: n
Do you want to use Elliptic Curve Cryptography (y/n)?: y
Enter length for elliptic curve to be used for PKI tree:
Possible values p256, p384, p521: p384
Enter the digest algorithm to use: sha384
Enter PKI tree duration (years): 5
Do you want the SRK certificates to have the CA flag set? (y/n)?: n
```

The script populates keys and crts folders within the CST root folder with private keys and appropriate certificates. Set the KEY_ROOT environment variable to absolute path to CST root folder (the folder containing keys and crts subfolders).

```
export KEY_ROOT=<cst_directory>
```

Build automatically fetches keys and certificates from this path to sign firmware binaries.

6.3.1.1 Prepare SRK table

CST provides srktool to prepare the SRK table from which SRKH value will be created.

```
cd <cst_directory>/crts
../linux64/bin/srktool -a -s sha384 -t SRKtable.bin -e SRKfuse.bin -f 1 -c
SRK1_sha384_secp384r1_v3_usr_crt.pem, SRK2_sha384_secp384r1_v3_usr_crt.pem,
```

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```
SRK3_sha384_secp384r1_v3_usr_crt.pem,SRK4_sha384_secp384r1_v3_usr_crt.pem
```

The program prints a summary with results:

```
Number of certificates
SRK table binary filename = SRKtable.bin
SRK Fuse binary filename = SRKfuse.bin
SRK Fuse binary dump:
SRK HASH[0] = 0x336D1608
SRK HASH[1] = 0 \times DFCC2D5E
SRK HASH[2] = 0xB582FA14
SRK HASH[3] = 0 \times DA325A05
SRK HASH[4] = 0xEAB66EDE
SRK HASH[5] = 0xB64F7A87
SRK HASH[6] = 0xC9CAD3BF
SRK HASH[7] = 0 \times 479 DC210
SRK HASH[8] = 0x79DA681C
SRK HASH[9] = 0x8C55E093
SRK HASH[10] = 0 \times 3 \times 6 \times 10^{-10}
SRK HASH[11] = 0xC7B6DDF0
SRK HASH[12] = 0 \times E0C3363E
SRK HASH[13] = 0x73D8A971
SRK HASH[14] = 0 \times 240 \text{AOEEE}
SRK HASH[15] = 0xE46CE431
```

The SRK HASH[] is SHA-512 hash of SRK table and is valid only for i.MX 8QXP family (i.MX 93 needs SHA-256 format). SRKH for i.MX 93 will be prepared later.

For more information on how to use srktool, see chapter 3.2.3 Generating AHAB SRK tables and Efuse Hash in $< cst_directory > /docs/CST_UG.pdf$

6.3.2 Building secured binary

With HAB/AHAB keys prepared, you are able to build a signed secure binary. Build the firmware with -t secured efi or -t secured uefi flag enabled, for example:

```
./buildme64.sh -b 8Mm -t all -t secured efi -nu
```

The command above produces win10-iot-bsp/imx-windows-iot/BSP/firmware/MX8M_MINI_EVK/signed flash.bin, which is a signed binary image containing all boot components.

6.3.3 Locking the device

Warning: CAUTION: Steps described in this section are irreversible. Always make sure you know what you are doing, any misconfiguration may lead to bricked device.

The following steps are only applicable for i.MX 8QXP and i.MX 93 SoC. For i.MX 8M, see section Locking the device (i.MX 8M) above.

Note: CST tool currently does not support i.MX 93 SRKH format. It is thus necessary to create the hash manually, follow "Preparing i.MX 93 SRKH".

This guide uses U-Boot's commandline interface as a tool for burning eFUSES.

6.3.3.1 Preparing SRKH

1. Enter the folder containing your SRKtable.bin

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- 2. Generate SRKH using the following command: openssl dgst -sha256 -binary SRKtable.bin > SRKfuse93.bin
- 3. Print contents of SRKH in the format used for writing to fuses: hexdump $-e '/4 "0x"' -e '/4 "%x"" \n"' < SRKfuse93.bin$

6.3.3.2 Burning SRK_HASH

- 1. Load a stock image to the SD card.
- 2. Enter U-Boot command-line interface (press escape on prompt during boot).
- 3. To find proper fuse indexes. see the fuse map for your device.
- 4. i.MX 8QXP: Burn SRK_HASH fuses with values from srktool see SRK_fuse.bin. Use the output values of srktool or use the following command: hexdump -e '/4 "0x"' -e '/4 "%X""\n"' < SRKfuse.bin
- 5. i.MX 93: Burn SRK HASH fuses with values from step 4 of "Preparing SRKH (imx93 only)" above.

```
# For i.MX93 only
# Dump SRKH to console
hexdump -e '/4 "0x"' -e '/4 "%X""\n"' < SRKfuse93.bin
0xA3B1A4B0
0x2AAEEEC5
0xCFC0D333
0xCC440EFC
0x73F4D517
0xC8D3F8A0
0xF8893889
0x42CF6504
```

```
# For i.MX93 only
# Write values to fuses via UBoot CLI
fuse prog -y 16 0 0xA3B1A4B0
fuse prog -y 16 1 0x2AAEEEC5
fuse prog -y 16 2 0xCFC0D333
fuse prog -y 16 3 0xCC440EFC
fuse prog -y 16 4 0x73F4D517
fuse prog -y 16 5 0xC8D3F8A0
fuse prog -y 16 6 0xF8893889
fuse prog -y 16 7 0x42CF6504
reset
```

The device now contains an SRK Hash composed of your PKI keys and is able to verify firmware binary signatures. Until locked, the device will still accept unsigned binaries and binaries with bad signature.

Tip: Before locking the chip, boot a signed image from the step <u>Building secured binary</u> and check AHAB events:

- 1. Prepare the SD card with secured binary.
- 2. Enter U-Boot command line.
- 3. Enter the ahab_status command.

The command must output the following text, indicating that all signatures are valid:

```
=> ahab_status
Lifecycle: 0x0020, NXP closed
No SECO Events Found!
```

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In case of any error, U-Boot prints and parses SECO events. Example for a missing signature:

6.3.3.3 Closing the chip

- 1. Load a stock image to the SD card (non-secure build).
- 2. Enter U-Boot command-line interface (press escape on prompt during boot).
- 3. Close the chip and reboot.

Example:

```
=> ahab_close
=> reset
```

The chip is now locked and accepts only firmware signed with appropriate keys. You can check that via $ahab_status$ command, the lifecycle must be 0x80 OEM closed.

```
=> ahab_status
Lifecycle: `0x80, OEM closed`
```

6.4 RPMB, UEFI

6.4.1 RPMB

The following steps for loading RPMB key are only applicable with device in the "closed" state.

Used OP-TEE implementation allows the use of Hardware-Unique key (HUK) that is accessible only from software running in secure world and thus unreachable from normal OS. This principle provides enhanced security since the key does not need to be stored in memory, it is generated on demand.

OP-TEE itself is able to burn the key, when built with CFG_RPMB_WRITE_KEY=y. The following steps guide you on how to prepare a "provisioning" build which contains OP-TEE with RPMB key provisioning enabled. OP-TEE uses HUK as RPMB key by default.

- 1. Re-build the firmware using buildme64.sh -b <board-type> -t all -t secured_efi -ao rpmb_write_key -ao no_rpmb_test_key and store the signed_firmware.bin separately. This firmware should be used only for RPMB provisioning (at secured place).
- 2. Burn the provisioning signed firmware.bin to the SD card and boot it.

OP-TEE automatically burns the RPMB key to eMMC controller during first boot. The RPMB is now fully provisioned and the boot process should now be unblocked and proceed to UEFI and Windows. You can now use your production signed firmware.bin. The boot chain is now secured up to UEFI firmware.

6.4.2 UEFI

Even with Secure Boot settings enabled, the UEFI firmware and Windows still reside in **setup mode**, where signatures are not checked. The UEFI automatically transfers to **user mode** with Secure Boot enabled when PK

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is written and the OS is restarted. For more details, see <u>Windows Secure Boot Key Creation and Management</u> Guidance.

6.5 Troubleshooting

6.5.1 Firmware built as secure fails to boot or hangs in UEFI

There may be a problem with RPMB, either the RPMB key was not written yet, or a different key is used.

```
AUTH-VAR[E]:TEEC OpenSession() failed. (TeecResult=0xFFFF0007) (TaOpenSession: /bsp/mu_platform_nxp/Microsoft/OpteeClientPkg/Drivers/AuthVarOpteeRuntimeDxe/AuthVarSDxe.c, 1027)
AUTH-VAR[E]:TaOpenSession() failed. (Status=Protocol Error) (VariableAuthOpteeRuntimeInitialize: /bsp/mu_platform_nxp/Microsoft/OpteeClientPkg/Drivers/AuthVarOpteeRuntimeDxe/AuthVarsDxe.c, 1554)
Error: Image at 000E1EF00000 start failed: Protocol Error
remove-symbol-file /bsp/mu_platform_nxp/Build/MEK_iMX80XP_3G8/DEBUG_GCC5/AARCH64/Microsoft/OpteeClientPkg/Drivers/AuthVarOpteeRuntimeDxe/AuthVarsDxe/DEBUG/VariableAuthOpteeRuntimeDxe.dll 0xE1F00000
AcpiPlatform.ef1
Error: Image at 000E6F44000 start failed: 00000001
remove-symbol-file /bsp/mu_platform_nxp/Build/MEK_iMX80XP_3G8/DEBUG_GCC5/AARCH64/MdeModulePkg/Universal/Acpi/AcpiPlatformDxe/AcpiPlatformDxe/DEBUG/AcpiPlatform.dll 0xE6F45000
SmblosPlatformDxe.ef1

Figure 14. RPMB key missing
```

6.5.2 Resolution

Re-build OP-TEE with debug prints enabled:

```
make PLATFORM=imx PLATFORM_FLAVOR=$optee_plat \
    CFG_TEE_CORE_DEBUG=y CFG_TEE_CORE_LOG_LEVEL=4 \
    CFG_RPMB_FS=y CFG_REE_FS=n \
    CFG_CORE_HEAP_SIZE=131072
```

Boot the device with new OP-TEE, review boot messages. Following messages are signalizing that there is a missing RPMB key:

```
D/TC:? 0 tee_rpmb_init:1122 RPMB: Syncing device information
D/TC:? 0 tee_rpmb_init:1130 RPMB: RPMB size is 32*128 KB
D/TC:? 0 tee_rpmb_init:1132 RPMB: Reliable Write Sector Count is 1
D/TC:? 0 tee_rpmb_init:1158 RPMB INIT: Deriving key
D/TC:? 0 tee_rpmb_key_gen:310 RPMB: Using test key
D/TC:? 0 tee_rpmb_key_gen:310 RPMB: Using test key
D/TC:? 0 tee_rpmb_init:1173 RPMB INIT: Verifying Key
E/TC:? 0 tee_rpmb_verify_key_sync_counter:1021 Verify key returning 0xffff0008
D/TC:? 0 tee_rpmb_init:1181 RPMB INIT: Auth key not yet written
D/TC:? 0 tee_rpmb_write_and_verify_key:1096 RPMB INIT: CFG_RPMB_WRITE_KEY is not set
Figure 15. RMPB no key log
```

Follow RPMB secure provisioning chapter.

7 Revision history

Table 2. Revision history

Revision number	Date	Substantive changes
W0.9.0	1/2022	Private preview release for i.MX8M platform.
W0.9.1	3/2022	Public preview release for i.MX8M platform.
W1.0.0	4/2022	Public release for i.MX8M and i.MX8M Mini platforms.
W1.1.0	6/2022	Public release for i.MX8M Nano and i.MX8M Plus platforms.
W1.2.0	9/2022	Section 1.7 is removed
W.1.2.1	10/2022	Updated for version 1.2.1

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Table 2. Revision history...continued

Revision number	Date	Substantive changes
W1.3.0	12/2022	Updated for version 1.3.0
W1.4.0	3/2023	Updated for version 1.4.0

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Contents

1	Overview	2	5.2.2.1	U-Boot SPL	18
1.1	Audience	2	5.2.2.2	Device Tree Blob	18
1.2	Conventions	2	5.2.2.3	OP-TEE	18
1.3	How to start	2	5.2.2.4	ATF	18
1.4	Using Prebuilt Binaries to create an image .	2	5.2.2.5	U-Boot proper	19
1.5	Using Source Files to create image	2	5.2.2.6	UEFI	19
1.6	References		5.2.3	Ensuring firmware security	19
2	Building Windows 10 IoT for NXP i.MX		5.2.3.1	Security configuration	
	Processors	3	5.2.3.2	Bootloader verification chain	
2.1	Building the drivers in the BSP		5.2.3.3	HAB Chain of trust	
2.1.1	Required tools		5.2.3.4	i.MX Firmware image verification	20
2.1.1.1	Visual Studio 2019		5.3	Secure boot on i.MX 8QXP	
2.1.1.2	Windows Kits from Windows 10, version		5.3.1	System boot on i.MX 8QXP	
	2004 (10.0.19041.685)	3	5.3.2	i.MX boot containers	
2.1.2	Obtaining sources for building the drivers		5.3.3	System boot components	
2.1.2.1	Preparing source for building the drivers		5.3.3.1	U-Boot SPL	
2.1.3	Structure of Windows driver sources		5.3.3.2	Device Tree Blob	
2.1.4	One-time environment setup		5.3.3.3	OP-TEE	23
2.1.5	Building the drivers		5.3.3.4	ATF	24
2.2	Building ARM64 Firmware	5	5.3.3.5	U-Boot proper	24
2.2.1	Required tools	5	5.3.3.6	UEFI	24
2.2.2	Obtaining sources for building ARM64		5.3.4	Ensuring firmware security	24
	Firmware	5	5.3.4.1	Security configuration	24
2.2.2.1	Preparing sources for building firmware	5	5.3.4.2	Bootloader verification chain	
2.2.3	Setting up your build environment	6	5.3.4.3	AHAB Chain of trust	25
2.2.4	Building the firmware	8	5.3.4.4	i.MX Firmware image verification	25
2.2.5	Common causes of build errors	10	5.4	Secure boot on i.MX 93	26
3	Display/GPU driver	10	5.4.1	System boot on i.MX 93	26
3.1	Display interface selection	10	5.4.2	i.MX Boot Containers	26
3.2	Display resolution and timing parameters	10	5.4.3	System boot components	27
3.2.1	HDMI display interface	11	5.4.3.1	U-Boot SPL	
3.2.2	LVDS, MIPI-DSI and Parallel display		5.4.3.2	Device Tree Blob	
	interfaces		5.4.3.3	OP-TEE	
3.3	Display specific parameters		5.4.3.4	ATF	
3.3.1	LVDS display interface		5.4.3.5	U-Boot proper	
3.3.2	MIPI-DSI display interface		5.4.3.6	UEFI	
3.4	Display support in firmware		5.4.4	Ensuring firmware security	
3.4.1	Firmware display interface selection	12	5.4.4.1	Security configuration	
3.4.2	Firmware display resolution		5.4.4.2	Bootloader verification chain	
4	Power management		5.4.4.3	AHAB Chain of trust	
4.1	Power management user scenarios	12	5.4.4.4	i.MX Firmware image verification	
4.2	Device power management DPM on i.MX		5.5	Secure storage	
	8/9 platforms	13	5.5.1	RPMB	
4.3	Processor power management PPM on		5.5.2	Secure vs. non-secure build	
	i.MX 8/9 platforms		5.5.2.1	Secure build	
4.4	Power management tools and debugging		5.5.2.2	Non-Secure build	
4.4.1	powercfg /a		5.6	Secure Boot in UEFI and Windows	
4.4.2	powercfg /sleepstudy		6	Secure provisioning	
4.4.3	powercfg /energy		6.1	Secure provisioning i.MX 8M	
4.4.4	WinDbg !fxdevice		6.1.1	Generate HAB keys	
5 = 1	Secure boot		6.1.1.1	Prepare SRK table	
5.1	Basic concepts		6.1.2	Building secured binary	
5.1.1	Soura host on i MV 9M		6.1.3	Locking the device for i.MX 8M	
5.2	Secure boot on i.MX 8M		6.1.4	Burning SRK_HASH	
5.2.1	System boot on i.MX 8M		6.1.5	Burning SEC_CONFIG	
5.2.2	System boot components	17	6.2	Secure provisioning i.MX 8QXP	34

NXP Semiconductors

IMXWGU

i.MX Windows 10 IoT User's Guide

6.2.1	Generate AHAB keys	34
6.2.1.1	Prepare SRK table	
6.2.2	Building secured binary	35
6.2.3	Locking the device (i.MX 8QXP)	35
6.2.3.1	Burning SRK_HASH	35
6.2.3.2	Closing the chip	37
6.3	Secure provisioning i.MX 93	37
6.3.1	Generate AHAB keys	
6.3.1.1	Prepare SRK table	37
6.3.2	Building secured binary	38
6.3.3	Locking the device	38
6.3.3.1	Preparing SRKH	38
6.3.3.2	Burning SRK_HASH	39
6.3.3.3	Closing the chip	40
6.4	RPMB, UEFI	40
6.4.1	RPMB	40
6.4.2	UEFI	40
6.5	Troubleshooting	41
6.5.1	Firmware built as secure fails to boot or	
	hangs in UEFI	41
6.5.2	Resolution	41
7	Revision history	41
8	Note about the source code in the	
	document	42
9	Legal information	

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